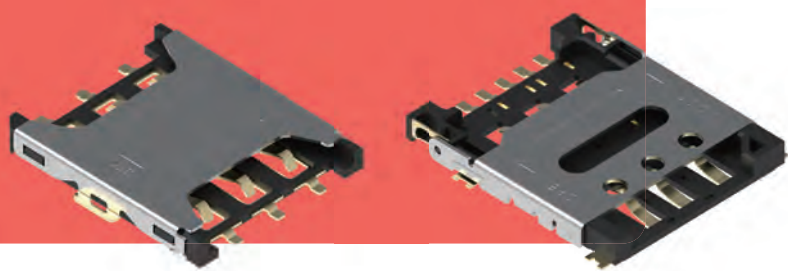
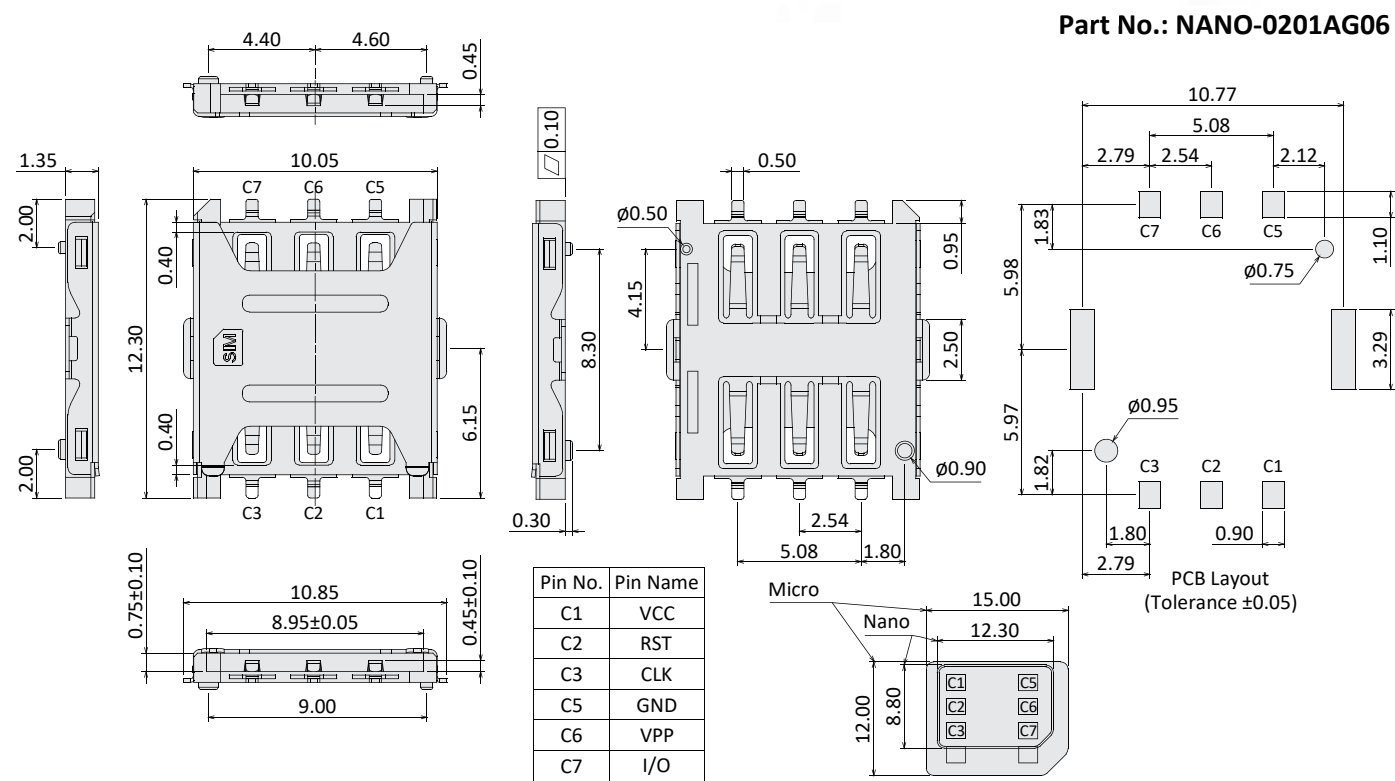


Nano SIM Card Connector

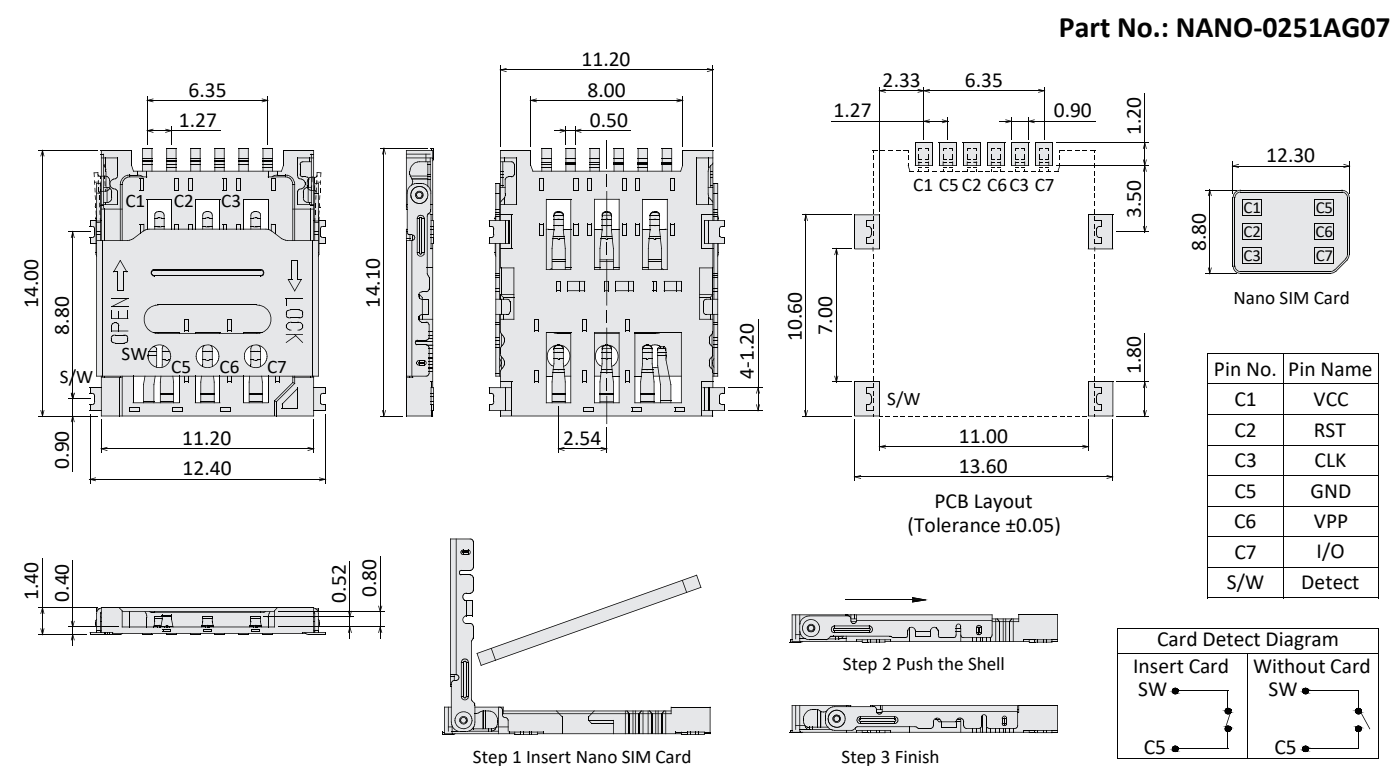
Current Rate: 0.5A
 Voltage Rate: 3.3V / 5.0V AC/DC
 Dielectric Voltage: 250V AC for one minute
 Insulation Resistance: 1000MΩ / 500MΩ Min.
 Contact Resistance: 100mΩ Max.
 Material Contact: Copper Alloy, Gold Plated
 Material Insulator: LCP, UL94V-0
 Operating Temperature: -40°C~+85°C



Nano SIM Card Conn. Push Pull Type H=1.35mm

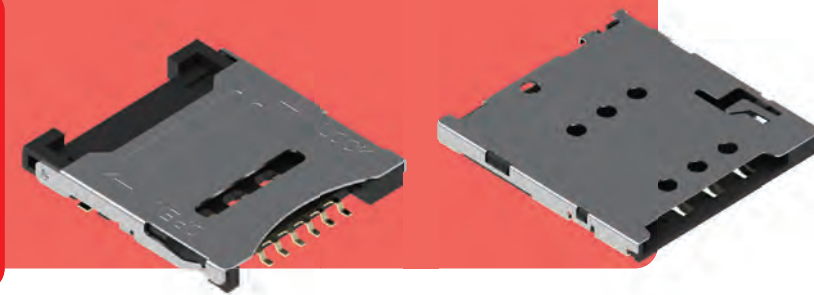


Nano SIM Card Conn. Hinge Type H=1.40mm

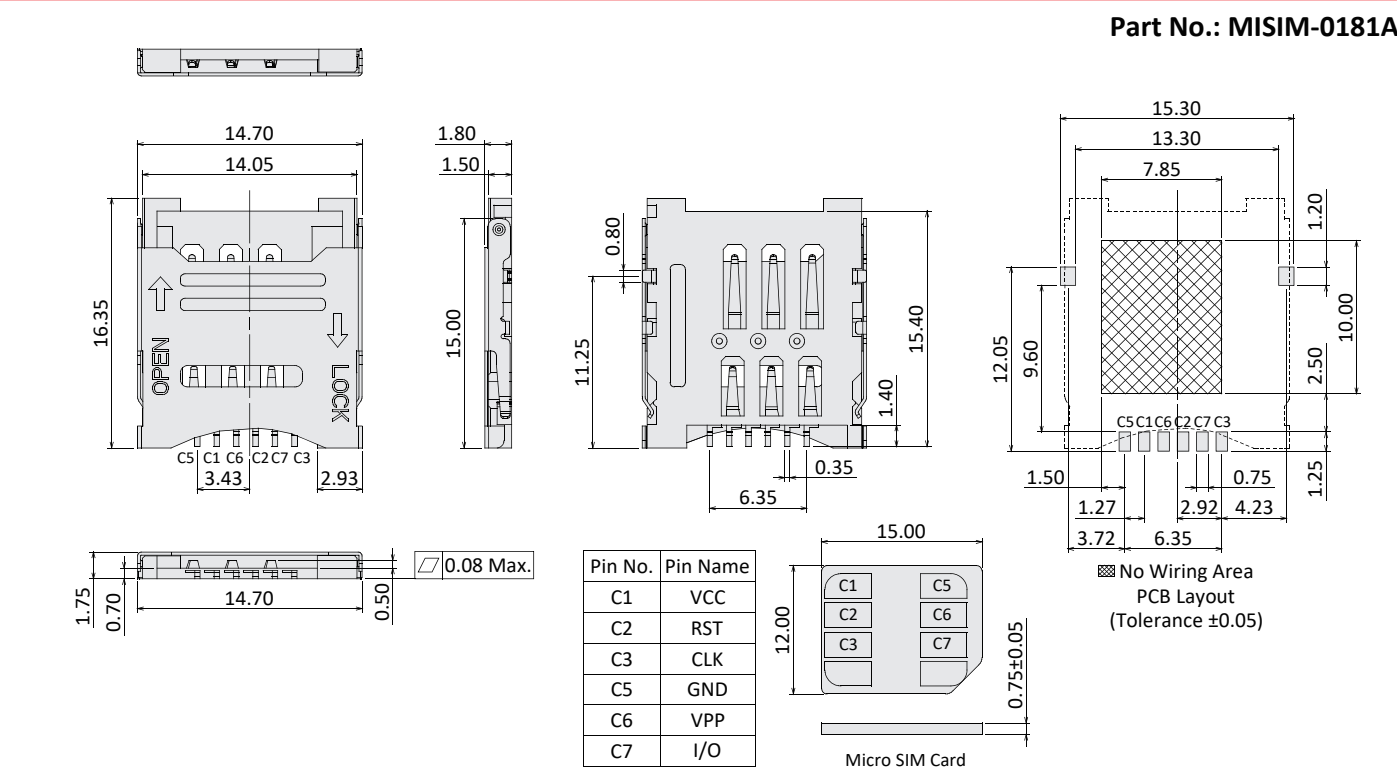


Micro SIM Card Connector

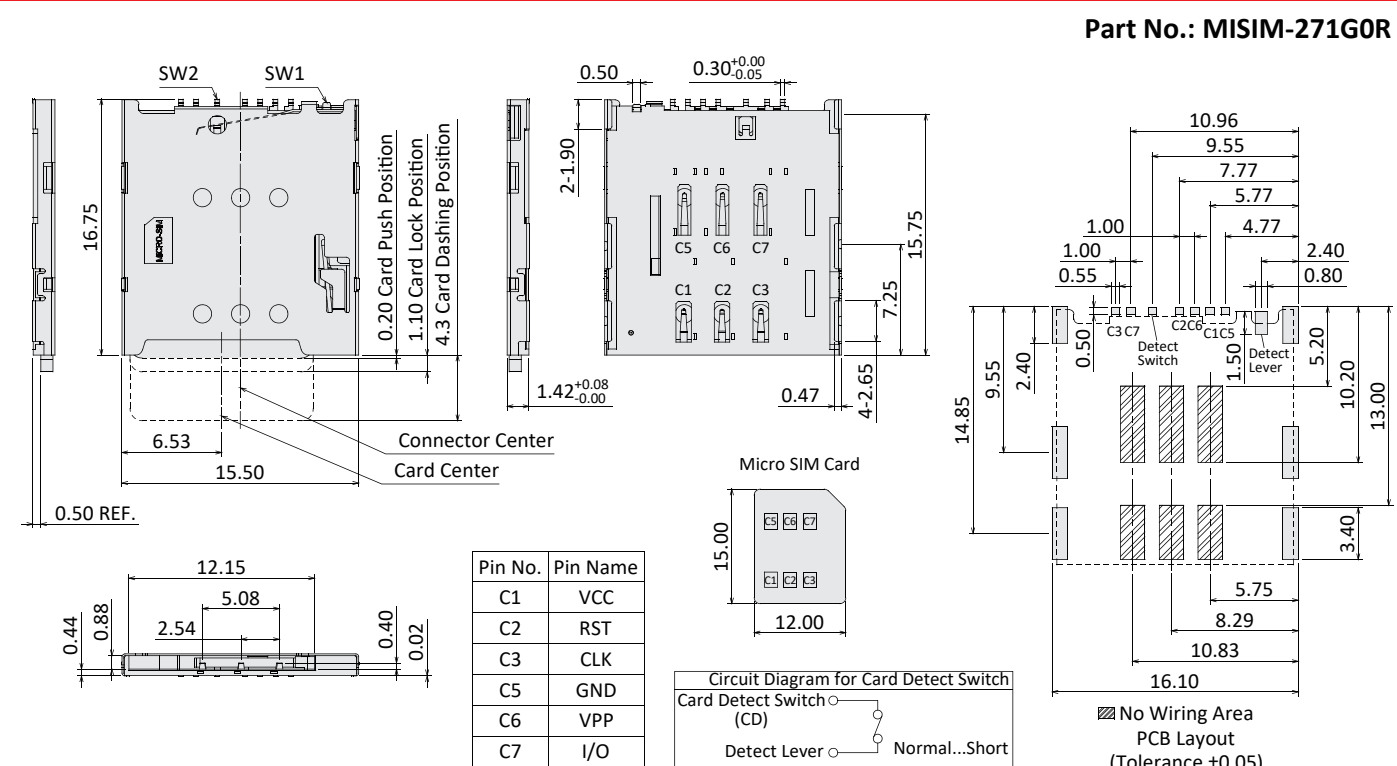
Current Rate: 1A / 0.5A
 Voltage Rate: 30V AC/DC
 Dielectric Voltage: 500V / 250V AC / minute
 Insulation Resistance: 1000MΩ Min.
 Contact Resistance: 30mΩ / 5vrms Max.
 Material Contact: Copper Alloy, Gold / Tin
 Material Insulator: LCP, UL94V-0
 Operating Temperature: -40°C~+85°C



Micro SIM Card Conn. Hinge Type H=1.80mm



Micro SIM Card Conn. Push Push Type H=1.42mm

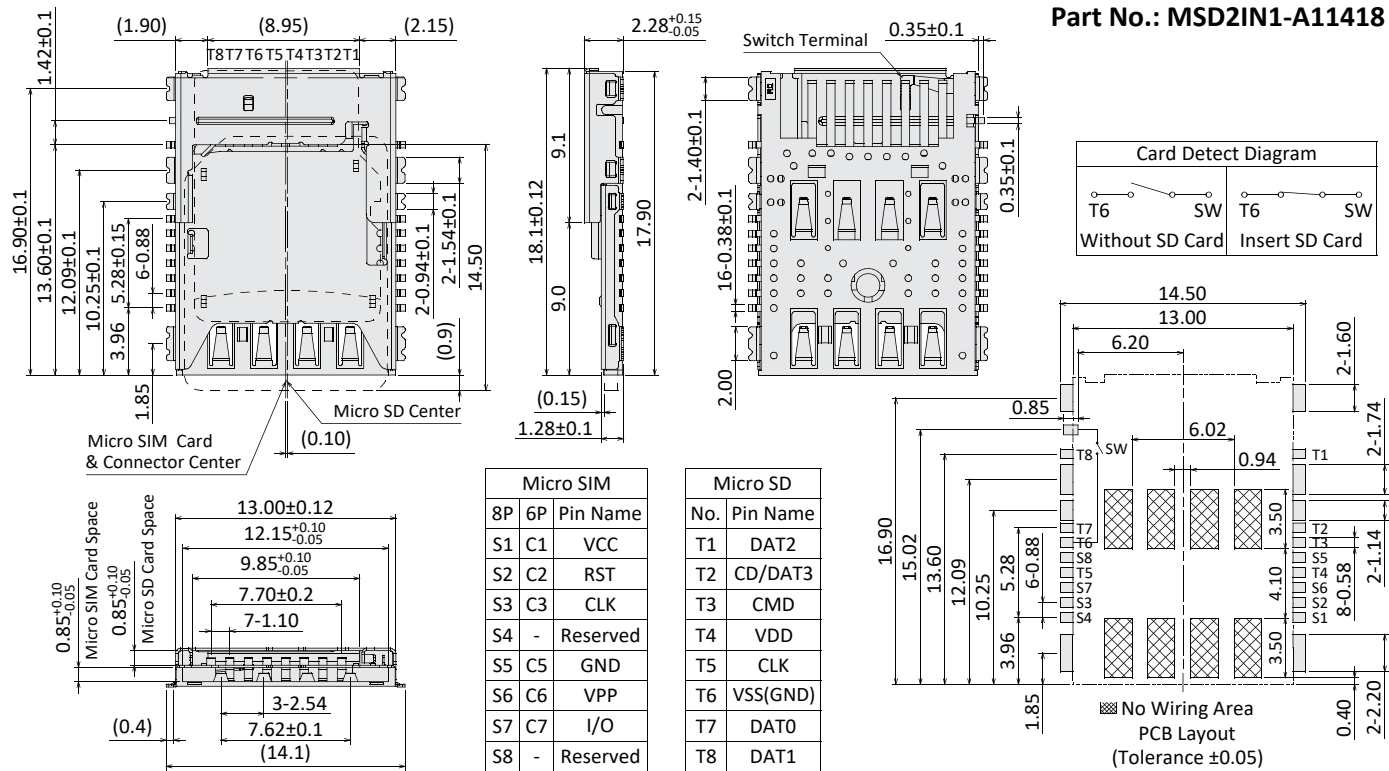


Micro SIM Card Connector

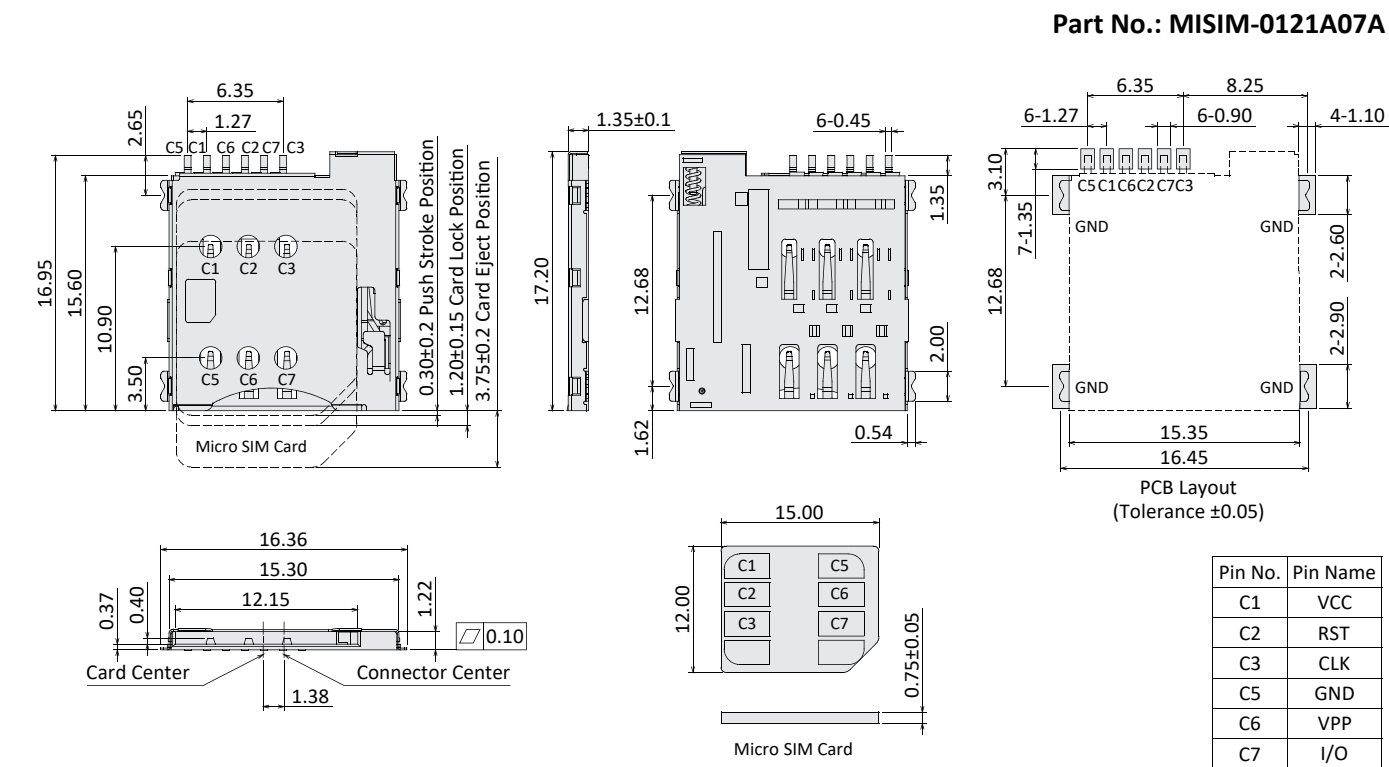
Current Rate: 0.5A
 Voltage Rate: 5V DC / 5.5V AC/DC
 Dielectric Voltage: 500V / 250V AC/minute
 Insulation Resistance: 1000MΩ Min.
 Contact Resistance: 100mΩ Max.
 Material Contact: Copper Alloy, Gold Plated
 Material Insulator: LCP, UL94V-0
 Operating Temperature: -40°C~+85°C



Micro SIM Card & Micro SD Card Conn. Combo Type H=2.28mm



Micro SIM Card Conn. Push Push Type H=1.35mm

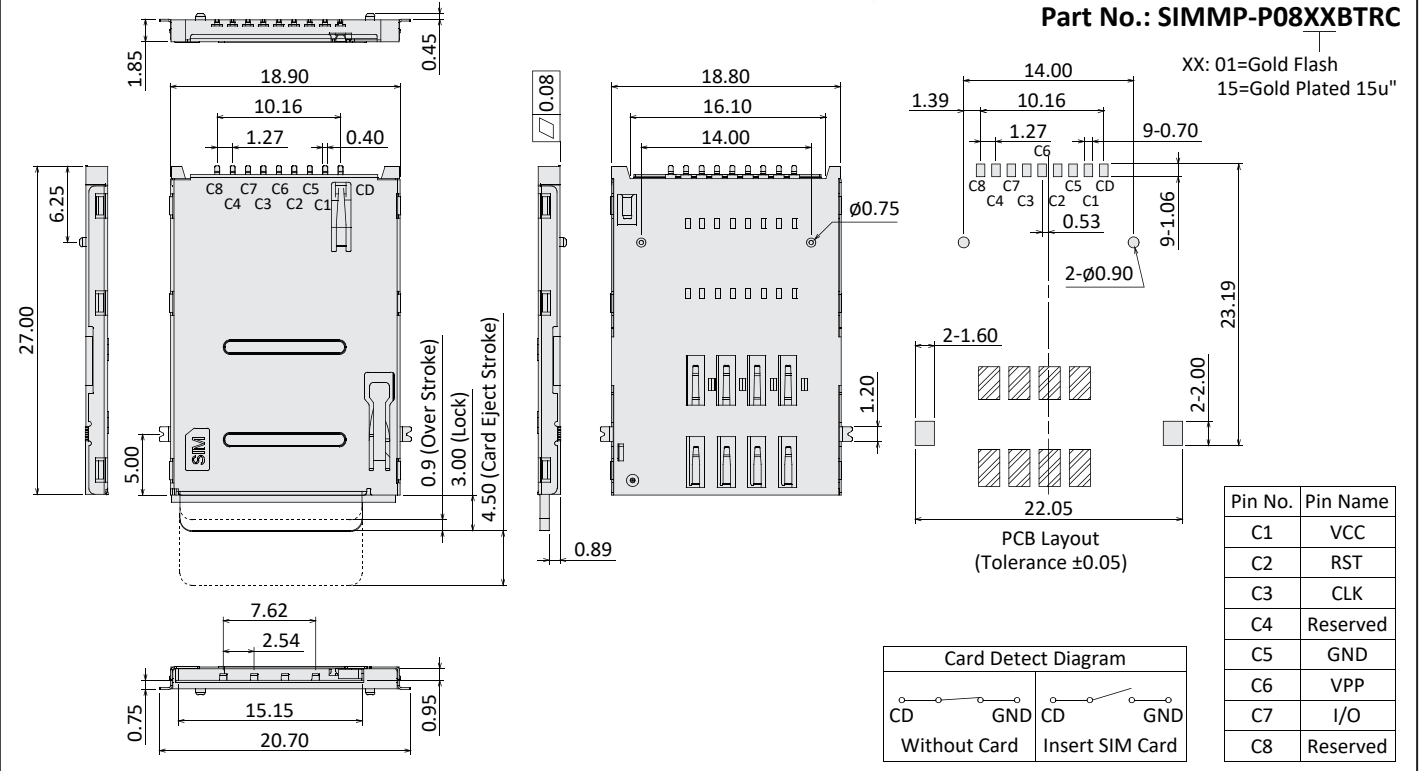


SIM Card Connector

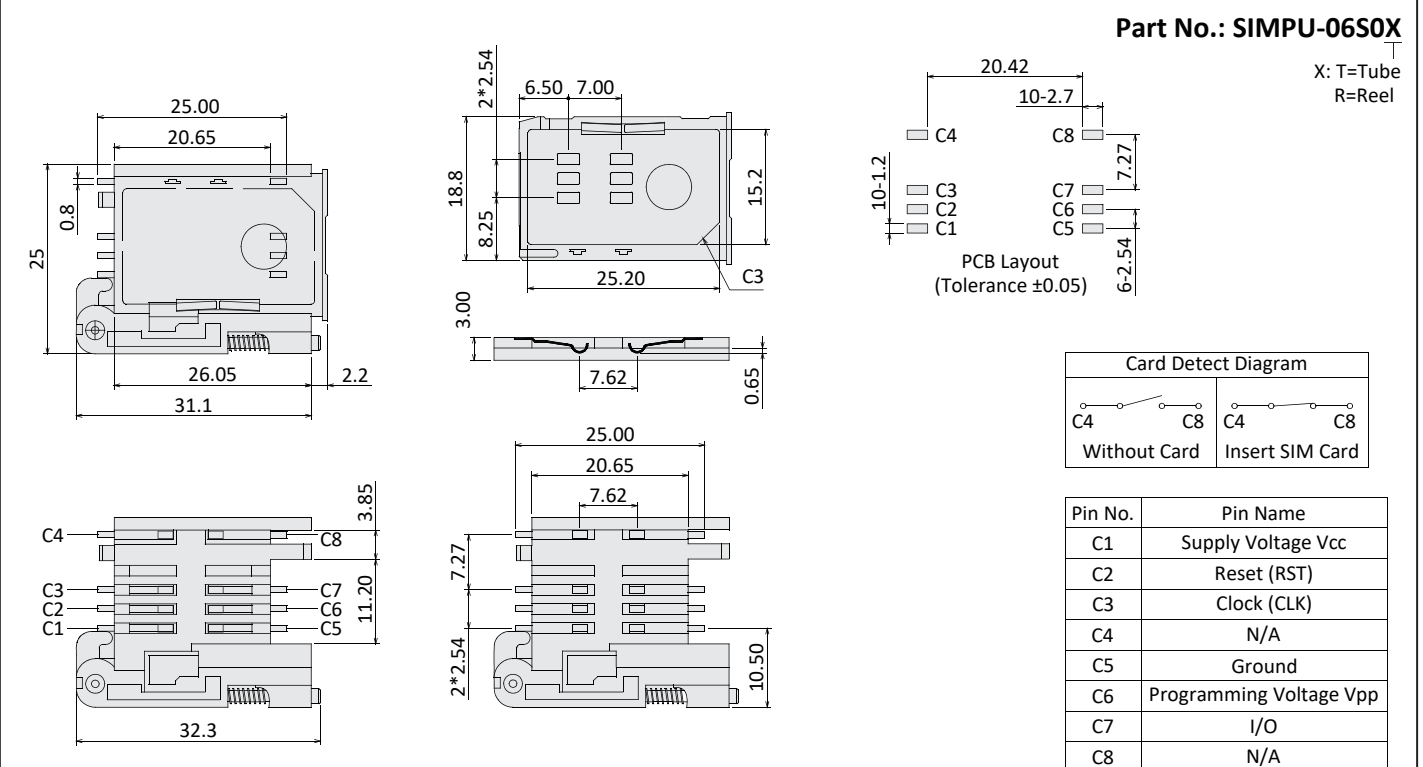
Current Rate: 0.5 / 3A
 Voltage Rate: 40V AC
 Dielectric Voltage: 500V AC for one minute
 Insulation Resistance: 1000MΩ Min.
 Contact Resistance: 30mΩ / 100mΩ Max.
 Material Contact: Copper Alloy, Gold / Tin
 Material Insulator: LCP, UL94V-0
 Operating Temperature: -40°C~+85°C



SIM Card Conn. Push Push Type H=1.85mm



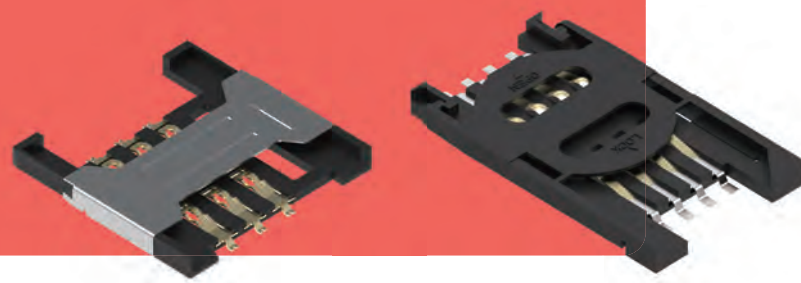
SIM Card Conn. Push Push Type H=3.00mm



SIM Card Connector

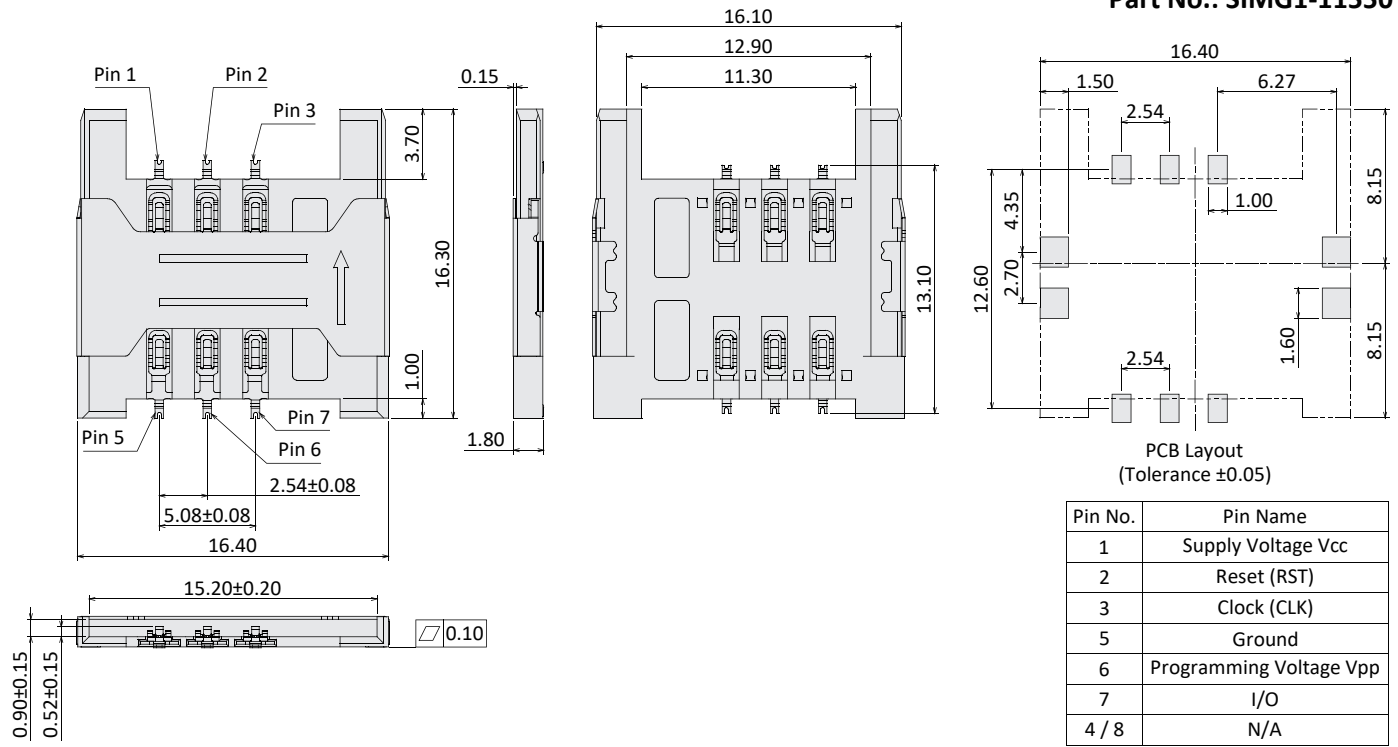
Card Slot

Current Rate: 1A / 0.5A
 Voltage Rate: 12V / 5V AC
 Dielectric Voltage: 250V / 500V AC/minute
 Insulation Resistance: 1000MΩ Min.
 Contact Resistance: 50mΩ / 60mΩ Max.
 Material Contact: Copper Alloy, Gold Plated
 Material Insulator: LCP, UL94V-0
 Operating Temperature: -40°C~+85°C



SIM Card Conn. Push Pull Type H=1.80mm

Part No.: SIMG1-11550



SIM Card Conn. Hinge Type H=2.35mm

Part No.: SCG0-08P2R

